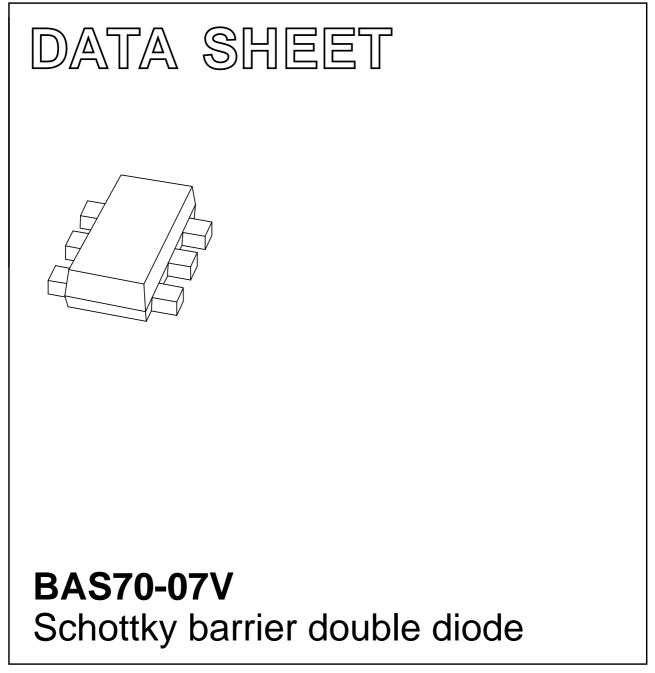
## DISCRETE SEMICONDUCTORS



Product specification

2002 Jan 17



## FEATURES

- Low forward voltage
- High reverse voltage
- Low capacitance
- Ultra small plastic SMD package
- Flat leads: excellent coplanarity and improved thermal behaviour.

## APPLICATIONS

- Ultra high-speed switching
- Voltage clamping
- Line termination
- Inverse-polarity protection
- RF applications (e.g. mixing and demodulation).

## DESCRIPTION

Planar Schottky barrier double diode with an integrated guard ring for stress protection.

Two separate dies encapsulated in a SOT666 ultra small SMD plastic package.

## LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
Per diode			L.		
V <sub>R</sub>	continuous reverse voltage		_	70	V
I <sub>F</sub>	continuous forward current		_	70	mA
I <sub>FRM</sub>	repetitive peak forward current	$t_p \le 1 \text{ s}; \delta \le 0.5$	_	70	mA
I <sub>FSM</sub>	non-repetitive peak forward current	t <sub>p</sub> < 10 ms	_	100	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
Tj	junction temperature		-	150	°C
T <sub>amb</sub>	operating ambient temperature		-65	+150	°C

## PINNING

PIN	DESCRIPTION
1	anode 1
2	not connected
3	cathode 2
4	anode 2
5	not connected
6	cathode 1

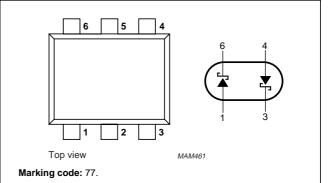


Fig.1 Simplified outline (SOT666) and symbol.

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## CHARACTERISTICS

 $T_{amb}$  = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MAX.	UNIT
V <sub>F</sub>	forward voltage	see Fig.2		
		I <sub>F</sub> = 1 mA	410	mV
		I <sub>F</sub> = 10 mA	750	mV
		I <sub>F</sub> = 15 mA	1	V
I <sub>R</sub>	reverse current	$V_R = 50$ V; note 1; see Fig.3	100	nA
		$V_R$ = 70 V; note 1; see Fig.3	10	μA
C <sub>d</sub>	diode capacitance	$V_R = 0$ ; f = 1 MHz; see Fig.5	2	pF

#### Note

1. Pulse test:  $t_p = 300 \ \mu s$ ;  $\delta = 0.02$ .

#### THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R <sub>th j-a</sub>	thermal resistance from junction to ambient	note 1	416	K/W

#### Note

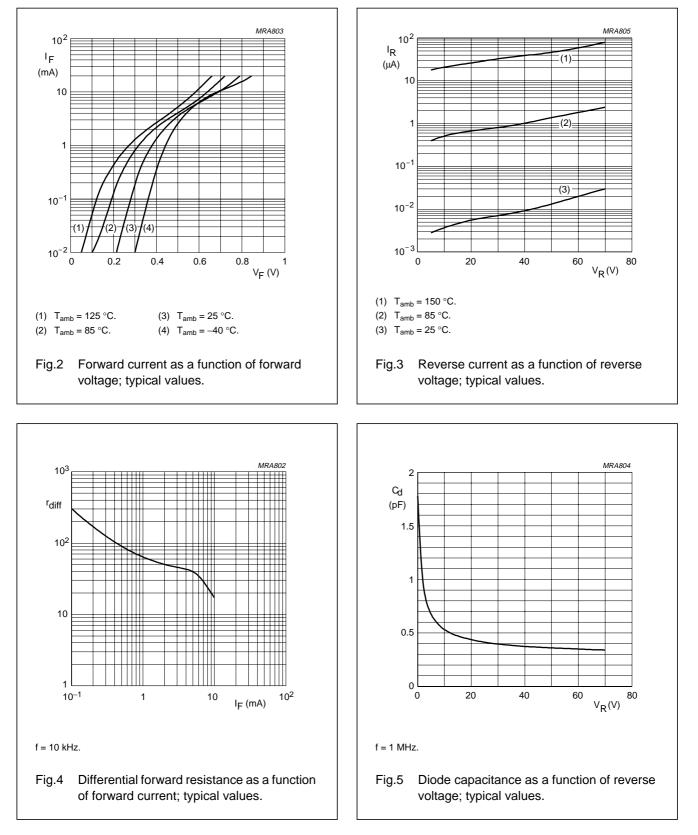
1. Refer to SOT666 standard mounting conditions.

## Soldering

The only recommended soldering is reflow soldering.

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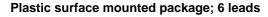
## **GRAPHICAL DATA**

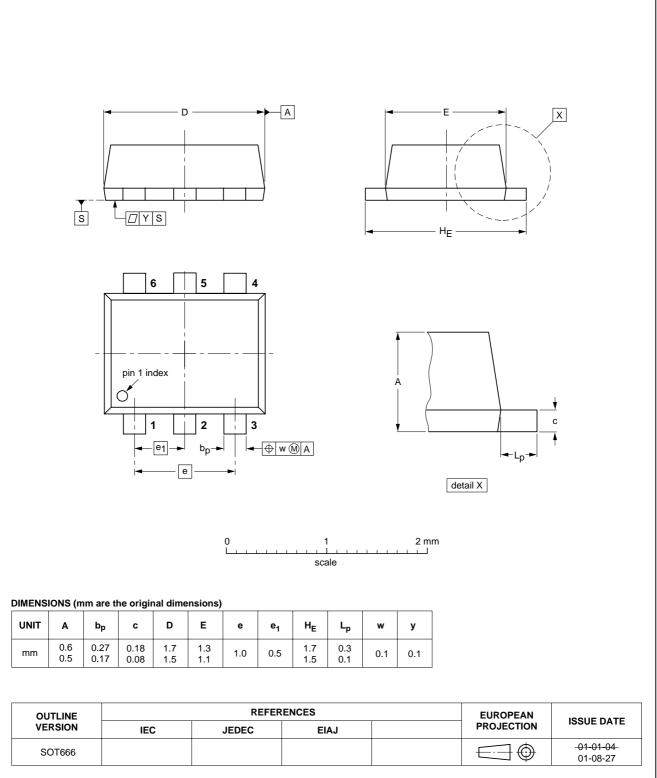


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## Schottky barrier double diode

## PACKAGE OUTLINE





**SOT666** 

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## DATA SHEET STATUS

DATA SHEET STATUS <sup>(1)</sup>	PRODUCT STATUS <sup>(2)</sup>	DEFINITIONS
Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
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#### **Contact information**

For additional information please visit http://www.semiconductors.philips.com. Fax: +31 40 27 24825 For sales offices addresses send e-mail to: sales.addresses@www.semiconductors.philips.com.

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